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Dated: April 30, 2009  
Electronic Signature for James E. Armstrong, IV: /James E. Armstrong, IV/

Docket No.: 80039(302720)  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Takuya Kodama et al.

Application No.: 10/568,277

Confirmation No.: 3107

Filed: November 9, 2006

Art Unit: 1796

For: PHENOLIC RESIN MOLDING MATERIAL  
AND RESIN SLIDING PART

Examiner: T. H. Yoon

**AMENDMENT AFTER FINAL ACTION UNDER 37 C.F.R. 1.116**

MS AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

DO NOT ENTER: /TY/

05/04/2009

Dear Sir/Madam:

Enter RCE  
06/01/09  
[Signature]

**INTRODUCTORY COMMENTS**

In response to the Office Action dated December 1, 2008, finally rejecting claims 1-4, 10 and 11 and enclosed herewith a two month Extension of Time, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 4 of this paper.